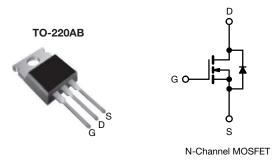
SiHP17N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	850			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.250		
Q _g max. (nC)	62			
Q _{gs} (nC)	8			
Q _{gd} (nC)	18			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{o(er)})
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP17N80AE-GE3

ABSOLUTE MAXIMUM RATINGS (Г _С = 25 °С, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain surrant (T 150 °C)	V _{GS} at 10 V	$V = \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	I _D	15	
Continuous drain current ($T_J = 150 \ ^{\circ}C$)	VGS at 10 V	T _C = 100 °C		10	А
Pulsed drain current ^a			I _{DM}	32	
Linear derating factor				1.4	W/°C
Single pulse avalanche energy ^b			E _{AS}	127	mJ
Maximum power dissipation			PD	179	W
Operating junction and storage temperature range	je		T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	
Reverse diode dv/dt ^d				17	V/ns
Soldering recommendations (peak temperature)	с	For 10 s		260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C



PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62 0.7		20.44		
Maximum junction-to-case (drain)	R _{thJC}	-				°C/W		
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	•	•						
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2	-	4	V
	1		$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zere gete veltage dreis surrent	1	V _{DS} =	= 800 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	/, V _{GS} = 0 V	′, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 8.5 A	-	0.250	0.290	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 10 V, I _D =	8.5 A	-	7.1	-	S
Dynamic	• •	•			•		•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1260	-	pF	
Output capacitance	C _{oss}			-	56	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related	C _{o(er)}	– V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	40	-		
Effective output capacitance, time related	C _{o(tr)}			-	245	-		
Total gate charge	Qg				-	41	62	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 8.5 \text{ A}, V_{DS} = 640 \text{ V}$		-	8	-	nC	
Gate-drain charge	Q _{gd}				-	18	-	
Turn-on delay time	t _{d(on)}				-	21	42	
Rise time	t _r	V _{DD} =	V_{DD} = 640 V, I _D = 8.5 A, V _{GS} = 10 V, R _g = 9.1 Ω		-	23	46	ns
Turn-off delay time	t _{d(off)}	V _{GS} =			-	45	90	
Fall time	t _f	1		-	31	62	1	
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	- A	
Pulsed diode forward current	I _{SM}			-	-	32		
Diode forward voltage	V _{SD}	T _J = 25 °C	C, I _S = 8.5 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	314	628	ns
Reverse recovery charge	Q _{rr}		5 °C, I _F = I _S		-	4	8	μC
, 0		di/dt = 100 A/µs, V _R = 25 V		_	21		A	



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

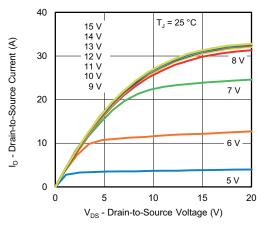


Fig. 1 - Typical Output Characteristics

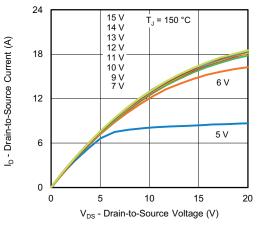


Fig. 2 - Typical Output Characteristics

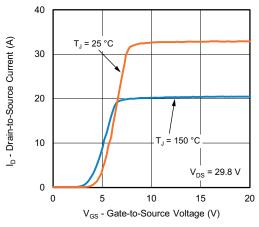


Fig. 3 - Typical Transfer Characteristics

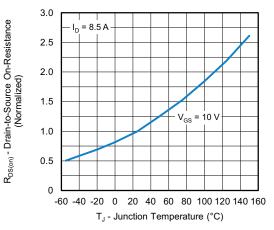


Fig. 4 - Normalized On-Resistance vs. Temperature

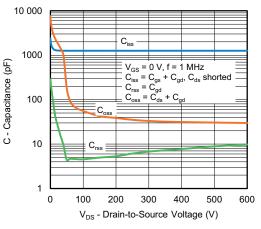
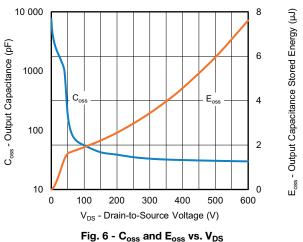


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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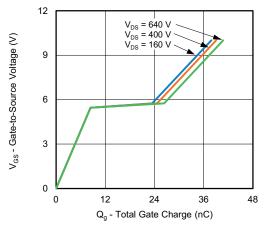


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

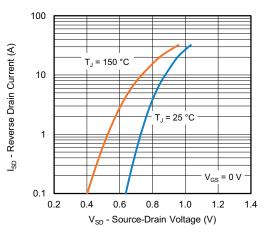


Fig. 8 - Typical Source-Drain Diode Forward Voltage

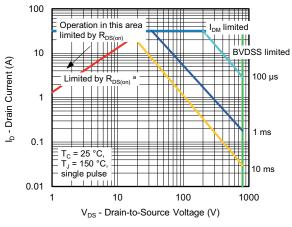


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

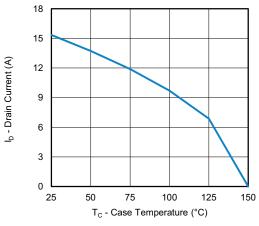


Fig. 10 - Maximum Drain Current vs. Case Temperature

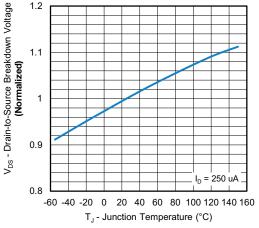


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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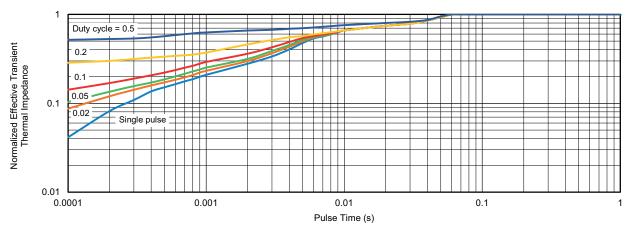


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

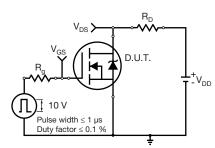


Fig. 13 - Switching Time Test Circuit

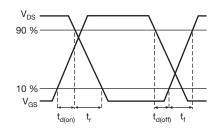


Fig. 14 - Switching Time Waveforms

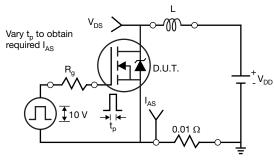


Fig. 15 - Unclamped Inductive Test Circuit

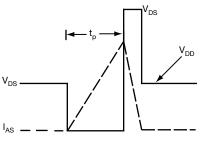


Fig. 16 - Unclamped Inductive Waveforms

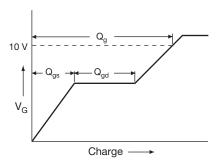
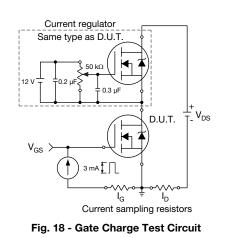


Fig. 17 - Basic Gate Charge Waveform

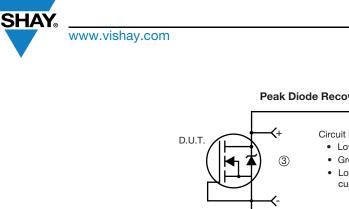


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Peak Diode Recovery dv/dt Test Circuit

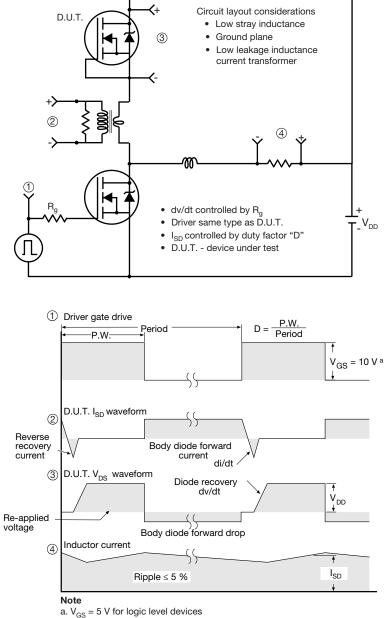


Fig. 19 - For N-Channel

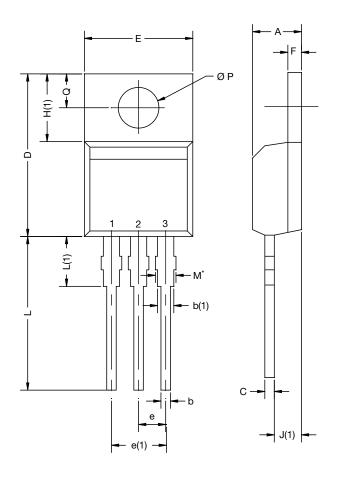
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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

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